

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









## 3.0mmx1.0 mm RIGHT ANGLE INFRARED **EMITTING DIODE**

Part Number: APA3010F3C-GX

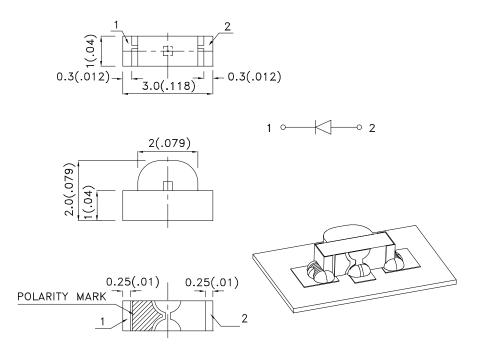
### **Features**

- 3.0mmx1.0mm right angle SMT LED, 2.0mm thickness.
- Mechanically and spectrally matched to phototransistor.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- Tinned pads for improved solderability.
- RoHS compliant.

## Description

F3 Made with Gallium Arsenide Infrared Emitting diodes.

## **Package Dimensions**



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.15(0.006") unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
   The device has a single mounting surface. The device must be mounted according to the specifications.



SPEC NO: DSAL3678 **REV NO: V.2A DATE: NOV/15/2011** PAGE: 1 OF 5 APPROVED: WYNEC DRAWN: Y.H.Wu ERP: 1203000562 **CHECKED: Allen Liu** 

## **Selection Guide**

Part No.	Dice	Lens Type	Po (mW/sr) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
APA3010F3C-GX	F3 (GaAs)	Water Clear	1.2	3	- 120°
			*0.8	*2	

- 1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

## Electrical / Optical Characteristics at TA=25°C

Parameter	P/N	Symbol	Тур.	Max.	Units	Test Conditions
Forward Voltage [1]	F3	VF	1.2	1.6	V	IF=20mA
Reverse Current	F3	lR		10	uA	V <sub>R</sub> = 5V
Capacitance	F3	С	90		pF	VF=0V;f=1MHz
Peak Spectral Wavelength	F3	λP	940		nm	IF=20mA
Spectral Bandwidth	F3	Δλ1/2	50		nm	IF=20mA

### Notes:

1.Forward Voltage: +/-0.1V.
2.Wavelength value is traceable to the CIE127-2007 compliant national standards.

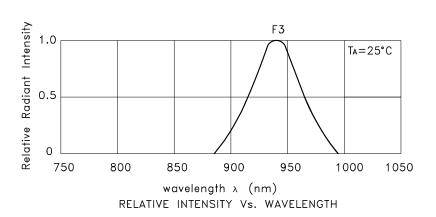
## Absolute Maximum Ratings at TA=25°C

Parameter         Symbol         F3           Power dissipation         PD         80           DC Forward Current         IF         50           Peak Forward Current [1]         iFS         1.2           Reverse Voltage         VR         5           Operating Temperature         TA         -40 To +85	Abbolato maximum ratingo at 171 20 0						
DC Forward Current         IF         50           Peak Forward Current [1]         iFS         1.2           Reverse Voltage         VR         5           Operating Temperature         TA         -40 To +85	arameter	Symbol	F3	Units			
Peak Forward Current [1]         iFS         1.2           Reverse Voltage         VR         5           Operating Temperature         TA         -40 To +85	ower dissipation	Po	80	mW			
Reverse Voltage VR 5 Operating Temperature TA -40 To +85	C Forward Current	lF	50	mA			
Operating Temperature TA -40 To +85	eak Forward Current [1]	iFS	1.2	А			
	leverse Voltage	VR	5	V			
	perating Temperature	Та	-40 To +85	°C			
Storage Temperature TstG -40 To +85	torage Temperature	Тѕтс	-40 To +85	°C			

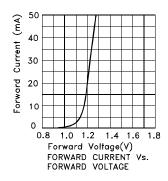
Note: 1. 1/100 Duty Cycle, 10µs Pulse Width.

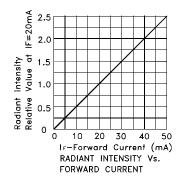
SPEC NO: DSAL3678 **REV NO: V.2A** DATE: NOV/15/2011 PAGE: 2 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: Y.H.Wu ERP: 1203000562

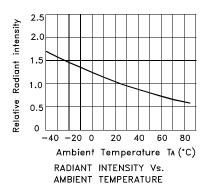
Radiant Intensity/ luminous flux: +/-15%.
 \*Radiant Intensity value is traceable to the CIE127-2007 compliant national standards.

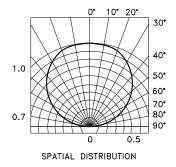


## APA3010F3C-GX









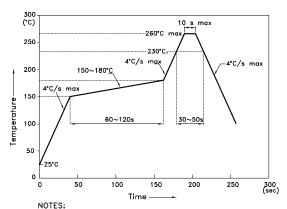
SPEC NO: DSAL3678 REV NO: V.2A DATE: NOV/15/2011 PAGE: 3 OF 5

APPROVED: WYNEC CHECKED: Allen Liu DRAWN: Y.H.Wu ERP: 1203000562

### APA3010F3C-GX

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

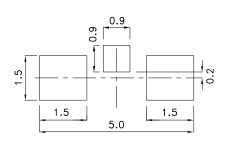
Reflow Soldering Profile For Lead-free SMT Process.



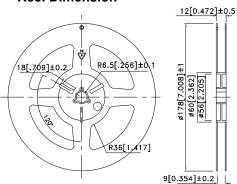
- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C).The maximum soldering temperature should be limited to 260°C. 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
   3.Number of reflow process shall be 2 times or less.

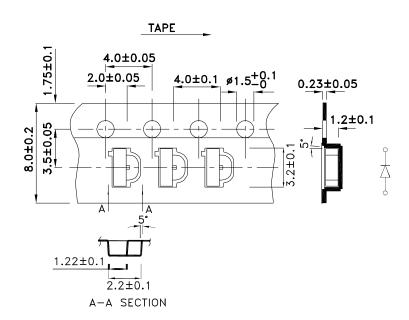
**Recommended Soldering Pattern** (Units: mm; Tolerance: ± 0.1)



## **Reel Dimension**



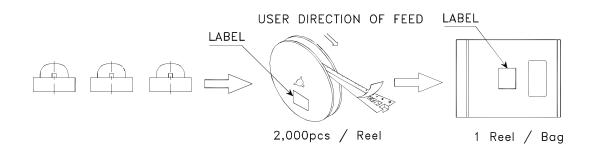
## **Tape Specifications** (Units: mm)

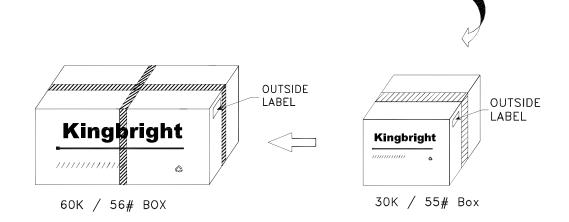


SPEC NO: DSAL3678 **REV NO: V.2A DATE: NOV/15/2011** PAGE: 4 OF 5 APPROVED: WYNEC **CHECKED: Allen Liu** DRAWN: Y.H.Wu ERP: 1203000562

## **PACKING & LABEL SPECIFICATIONS**

### APA3010F3C-GX







SPEC NO: DSAL3678
APPROVED: WYNEC

REV NO: V.2A CHECKED: Allen Liu DATE: NOV/15/2011 DRAWN: Y.H.Wu PAGE: 5 OF 5 ERP: 1203000562